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U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE

INFORMATION DISCLOSURE
STATEMENT

Docket Number:
11403/13

Technology Center 2600

Application Number
10/092,890

Filing Date
March 6, 20021

Examiner
To be Assigned

Art Unit
2661

Invention Title
SI WAFER-CAP WAFER BONDING METHOD
USING LOCAL LASER ENERGY, DEVICE,
PRODUCED BY THE METHOD, AND SYSTEM
USED IN THE METHOD

Inventors
Markus LUTZ

Hereby certify that this correspondence is being deposited with the
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Date: 5/30/03

Signature:

B. Haxman

1. In accordance with the duty of disclosure under 37 C.F.R. § 1.56 and in conformance with the procedures of 35 U.S.C. §§ 1.97 and 1.98 and M.P.E.P. § 609, attorneys for Applicants hereby bring the following reference to the attention of the Examiner. This reference is listed on the attached modified PTO Form No. 1449. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the reference be made of record therein and appear among the "References Cited" on any patent to issue therefrom.
2. A copy of the information listed on the modified PTO Form 1449 is enclosed.
3. It is believed that no fees are due in connection with this Information Disclosure Statement. However, should any fees be due, the Commissioner is authorized to charge Deposit Account No. 11-0600 for such fees. A duplicate of this communication is enclosed for charging purposes.

Dated: 5/30/03

By:

Richard L. Mayer
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